

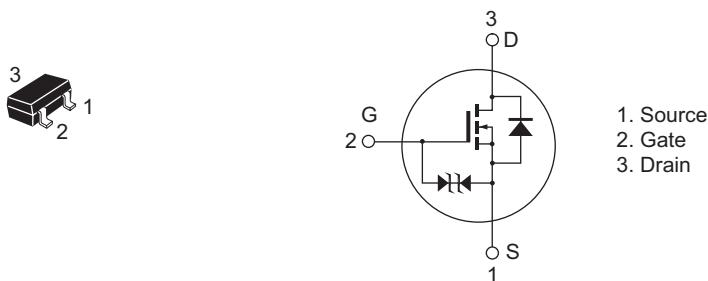
# RQK0303MGDQA

## Features

- Low on-resistance  
 $R_{DS(on)} = 42 \text{ m}\Omega$  typ ( $V_{GS} = 10 \text{ V}$ ,  $I_D = 1.8 \text{ A}$ )
- Low drive current
- High speed switching
- 4.5 V gate drive

## Outline

(Package name: MPAK)



Note: Marking is "MG".

## Absolute Maximum Ratings

(Ta = 25°C)

Item	Symbol	Ratings	Unit
Drain to source voltage	V <sub>DSS</sub>	30	V
Gate to source voltage	V <sub>GSS</sub>	±20	V
Drain current	I <sub>D</sub>	3.7	A
Drain peak current	I <sub>D(Pulse)</sub> <sup>Note1</sup>	5	A
Body - drain diode reverse drain current	I <sub>DR</sub>	3.7	A
Channel dissipation	P <sub>ch</sub> <sup>Note2</sup>	0.8	W
Channel temperature	T <sub>ch</sub>	150	°C
Storage temperature	T <sub>stg</sub>	-55 to +150	°C

Notes: 1. PW ≤ 10 μs, duty cycle ≤ 1%  
 2. When using the glass epoxy board (FR-4: 40 × 40 × 1 mm)

# RQK0303MGDQA

## Electrical Characteristics

(Ta = 25°C)

Item	Symbol	Min	Typ	Max	Unit	Test conditions
Drain to source breakdown voltage	V <sub>(BR)DSS</sub>	30	—	—	V	I <sub>D</sub> = 10 mA, V <sub>GS</sub> = 0
Gate to source breakdown voltage	V <sub>(BR)GSS</sub>	±20	—	—	V	I <sub>G</sub> = ±100 μA, V <sub>DS</sub> = 0
Gate to source leak current	I <sub>GSS</sub>	—	—	±10	μA	V <sub>GS</sub> = ±16 V, V <sub>DS</sub> = 0
Drain to source leak current	I <sub>DSS</sub>	—	—	1	μA	V <sub>DS</sub> = 30 V, V <sub>GS</sub> = 0
Gate to source cutoff voltage	V <sub>GS(off)</sub>	1.0	—	2.0	V	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1 mA
Drain to source on state resistance	R <sub>DS(on)</sub>	—	42	53	mΩ	I <sub>D</sub> = 1.8 A, V <sub>GS</sub> = 10 V <sup>Note3</sup>
	R <sub>DS(on)</sub>	—	50	70	mΩ	I <sub>D</sub> = 1.8 A, V <sub>GS</sub> = 4.5 V <sup>Note3</sup>
Forward transfer admittance	y <sub>fs</sub>	3.9	6.5	—	S	I <sub>D</sub> = 1.8 A, V <sub>DS</sub> = 10 V <sup>Note3</sup>
Input capacitance	C <sub>iss</sub>	—	550	—	pF	V <sub>DS</sub> = 10 V, V <sub>GS</sub> = 0, f = 1 MHz
Output capacitance	C <sub>oss</sub>	—	87	—	pF	
Reverse transfer capacitance	C <sub>rss</sub>	—	42	—	pF	
Turn - on delay time	t <sub>d(on)</sub>	—	13	—	ns	
Rise time	t <sub>r</sub>	—	39	—	ns	I <sub>D</sub> = 1 A, V <sub>GS</sub> = 10 V, R <sub>L</sub> = 10 Ω, R <sub>g</sub> = 4.7 Ω
Turn - off delay time	t <sub>d(off)</sub>	—	46	—	ns	
Fall time	t <sub>f</sub>	—	114	—	ns	
Total gate charge	Q <sub>g</sub>	—	8.9	—	nC	
Gate to source charge	Q <sub>gs</sub>	—	1.0	—	nC	V <sub>DD</sub> = 10 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 3.7A
Gate to drain charge	Q <sub>gd</sub>	—	1.3	—	nC	
Body - drain diode forward voltage	V <sub>DF</sub>	—	0.8	—	V	I <sub>F</sub> = 1.5 A, V <sub>GS</sub> = 0 <sup>Note3</sup>

Notes: 3. Pulse test